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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)Kuang-Hua LIU
Min-O HUANGAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No**3. Nature of conveyance/Execution Date(s):**

Execution Date(s) 09-30-2005

- ☒ Assignment 5CM200506US ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ Joint Research Agreement
- ☐ Government Interest Assignment
- ☐ Executive Order 9424, Confirmatory License
- ☐ Other _____

2. Name and address of receiving party(ies)Name: ChipMos Technologies Inc.

Internal Address: _____

Street Address: No. 1, Yanfa 1st Rd.Hsinchu Science ParkCity: Hsinchu City

State: _____

Country: Taiwan, R.O.C. Zip: 300Additional name(s) & address(es) attached? ☒ Yes ☐ No**4. Application or patent number(s):**☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No**5. Name and address to whom correspondence concerning document should be mailed:**Name: Andrew D. Fortney, Ph.D.Internal Address: The Law Offices of Andrew D. Fortney, Ph.D., P.C.Street Address: 7257 N. Maple Ave., Suite 107City: FresnoState: CA Zip: 93720Phone Number: 559-299-0128Fax Number: 559-299-0118Email Address: drew@fortneylaw.com**6. Total number of applications and patents involved:** 1**7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.**

- ☒ Authorized to be charged by credit card
- ☐ Authorized to be charged to deposit account
- ☐ Enclosed
- ☐ None required (government interest not affecting title)

8. Payment Informationa. Credit Card Last 4 Numbers 1447
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b. Deposit Account Number _____

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9. Signature:

Signature

12-22-2005

Date

Andrew D. Fortney, Ph.D.

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

4

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PATENT
REEL: 017415 FRAME: 0525

**Recordation Form Cover Sheet Additional Name(s) and Address(es) of
Receiving Parties**

Name: ChipMos Technologies (Bermuda) LTD.

Street Address: Canon's COURT, 22 Victoria STREET

City: Hamilton

Country: Bermuda

Zip: HM12

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

LIU, KUANG-HUA; HUANG, MIN-O

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

FLEXIBLE SUBSTRATE FOR PACKAGE

Do hereby sell, assign and transfer to ChipMos Technologies Inc., corporation of Taiwan (R.O.C) & ChipMos Technologies (Bermuda) LTD, corporation of Bermuda, having a place of business at No. 1, Yanfa 1st Rd., Hsinchu Science Park, Hsinchu City, Taiwan 300, R.O.C. & Canon's COURT, 22 Victoria STREET, Hamilton HM12, Bermuda, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

Agree that ChipMos Technologies Inc. & ChipMos Technologies (Bermuda) LTD, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.

Full Name of Sole/ First Inventor:	
LIU, KUANG-HUA	
Inventor's Signature:	Date: Month/Day/Year
<i>Liu Kuang Hua</i>	<i>08/30/2005</i>

Full Name of Second Inventor, if any:	
HUANG, MIN -O	
Inventor's Signature:	Date: Month/Day/Year
<i>Huang, Min -O</i>	<i>09/30/2005</i>

Full Name of Third Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year

Full Name of Fourth Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year

Full Name of Fifth Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year

Full Name of Sixth Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year